

HMC274QS16

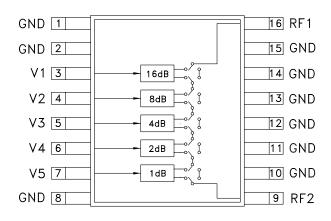
1 dB LSB GaAs IC 5-BIT DIGITAL ATTENUATOR, 0.7 - 2.7 GHz

Typical Applications

The HMC274QS16 is ideal for:

- Cellular/PCS/3G Infrastructure
- 2.4 GHz ISM Radios
- Wireless Data

Functional Diagram



Features

1 dB LSB Steps to 31 dB Single Positive Control (+3 to +5V) Per Bit +/- 0.5 dB Typical Bit Error Small QSOP16 Plastic Package

General Description

The HMC274QS16 is a broadband 5-bit positive control GaAs IC digital attenuator in a 16 lead QSOP plastic package. Covering 0.7 to 2.7 GHz the insertion loss is typically less than 2.3 dB. The attenuator bit values are 1 (LSB), 2, 4, 8, and 16 dB for a total attenuation of 31 dB. Accuracy is excellent at \pm 0.5 dB typical with an IIP3 of up to \pm 50 dBm. Five bit control voltage inputs, toggled between 0 and \pm 3 to \pm 5 volts, are used to select each attenuation state. A single Vdd bias of \pm 3 to \pm 5 volts applied through an external 5K Ohm resistor is required.

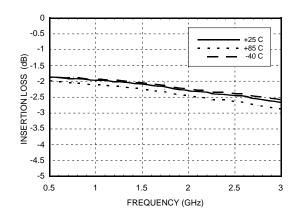
Electrical Specifications, $T_A = +25^{\circ} C$, Vdd = +3V to +5V & Vctl = 0/Vdd

| Parameter | | Frequency | Min. | Typical | Max. | Units |
|---|----------------------|---|----------|---|-------------------|----------------|
| Insertion Loss | | 0.7 - 1.4 GHz 1.4 - 2.3 GHz 2.3 - 2.7 GHz | | 2.0 2.3 2.5 | 2.4 2.7 3.1 | dB dB dB |
| Attenuation Range | | 0.7 - 2.7 GHz | | 31 | | dB |
| Return Loss (RF1 & RF2, All Atten. States) | | 0.7 - 1.4 GHz 1.4 - 2.7 GHz | 10 12 | 15 17 | | dB dB |
| Attenuation Accuracy: (Referenced to Insertion Los All Attenuation States All Attenuation States All Attenuation States | es) | 0.7 - 1.4 GHz 1.4 - 2.3 GHz 2.3 - 2.7 GHz | ± 0.25 + | 5% of Atten. Se 3% of Atten. Se 5% of Atten. Se | etting Max | dB dB dB |
| Input Power for 0.1 dB Compression | Vdd = 5V Vdd = 3V | 0.7 - 2.7 GHz | | 29 20 | | dBm dBm |
| Input Third Order Intercept Point (Two-tone Input Power = 0 dBm Each Tone) | Vdd = 5V Vdd = 3V | 0.7 - 2.7 GHz | | 54 52 | | dBm dBm |
| Switching Characteristics | | 0.7 - 2.7 GHz | | | | |
| tRISE, tFALL (10/90% RF) tON, tOFF (50% CTL to 10/90% RF) | | | | 560 600 | | ns ns |



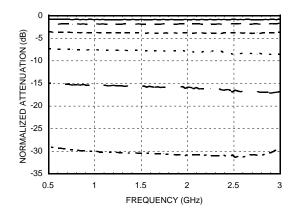
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Insertion Loss



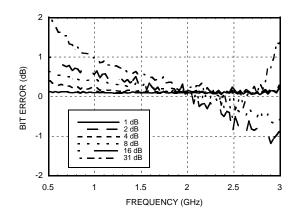
Normalized Attenuation

(Only Major States are Shown)



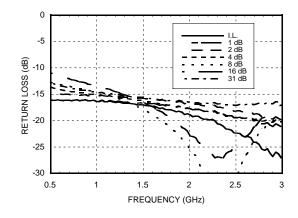
Bit Error vs. Frequency

(Only Major States are Shown)

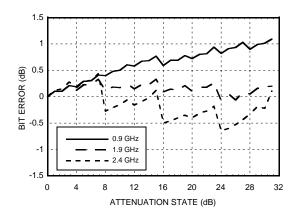


Note: All Data Typical Over Voltage (+3V to +5V).

Return Loss RF1, RF2 (Only Major States are Shown)

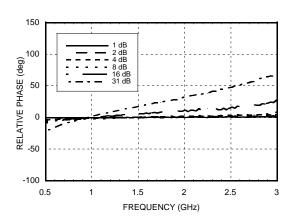


Bit Error vs. Attenuation State



Relative Phase vs. Frequency

(Only Major States are Shown)



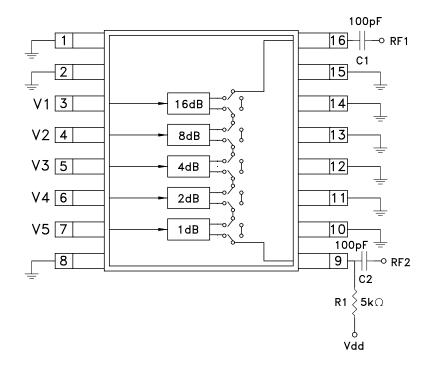


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Compression Point & IP3

| Attenuation Control | | Input P1dB (dBm) | | Input P0.1dB (dBm) | | | Input IP3 (dBm) | | | |
|---------------------|-------------|------------------|------|--------------------|------|------|-----------------|------|-------|------|
| State (dB) | Voltage (V) | +25C | +85C | -40C | +25C | +85C | -40C | +25C | +85C | -40C |
| 1 | 5 | 32.3 | 31.8 | 32.9 | 29.4 | 28.8 | 29.8 | 54.7 | 49.1 | 52.2 |
| 2 | 5 | 32.3 | 31.8 | 32.8 | 29.2 | 28.6 | 29.4 | 52.2 | 49.1 | 52.2 |
| 4 | 5 | 32.8 | 32.1 | 33.3 | 29.4 | 28.7 | 29.3 | 54.1 | 48.65 | 52.7 |
| | | | | | | | | | | |
| 1 | 3 | 24.8 | 25.7 | 25.2 | 19.7 | 18.6 | 21.1 | 52.2 | 48.1 | 52.5 |
| 2 | 3 | 24.7 | 24.1 | 25.1 | 19.7 | 18.3 | 21.0 | 52.2 | 48.1 | 52.2 |
| 4 | 3 | 26.0 | 25.6 | 26.6 | 19.6 | 18.6 | 21.1 | 53.1 | 47.65 | 53.2 |

Application Circuit



DC blocking capacitors C1 & C2 are required on RF1 & RF2. Choose C1 = C2 = 100 ~ 300 pF to allow lowest customer specific frequency to pass with minimal loss. R1 = 5K Ohm is required to supply voltage to the circuit through either PIN 9 or PIN 16.



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Truth Table

| | Cont | Attenuation | | | |
|-------------|------------|-------------|------------|------------|----------------------|
| V1 16 dB | V2 8 dB | V3 4 dB | V4 2 dB | V5 1 dB | Setting RF1 - RF2 |
| High | High | High | High | High | Reference I.L. |
| High | High | High | High | Low | 1 dB |
| High | High | High | Low | High | 2 dB |
| High | High | Low | High | High | 4 dB |
| High | Low | High | High | High | 8 dB |
| Low | High | High | High | High | 16 dB |
| Low | Low | Low | Low | Low | 31 dB Max. Atten. |

Any combination of the above states will provide an attenuation approximately equal to the sum of the bits selected.

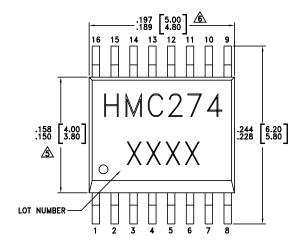
Control Voltages

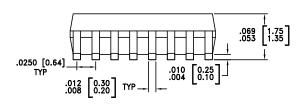
| State | Bias Condition | |
|------------------------------|-------------------------|--|
| Low | 0 to +0.2 V @ 20 uA Max | |
| High | Vdd ± 0.2V @ 100 uA Max | |
| Note: Vdd = +3V to 5V ± 0.2V | | |

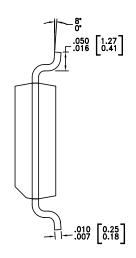
Absolute Maximum Ratings

| Control Voltage (V1 - V5) | Vdd + 0.5 Vdc |
|--------------------------------|----------------|
| Bias Voltage (Vdd) | +8.0 Vdc |
| Storage Temperature | -65 to +150 °C |
| Operating Temperature | -40 to +85 °C |
| RF Input Power (0.7 - 2.7 GHz) | +30 dBm |

Outline Drawing







NOTES

- PACKAGE BODY MATERIAL: LOW STRESS INJECTION MOLDED PLASTIC SILICA AND SILICON IMPREGNATED.
- 2. LEADFRAME MATERIAL: COPPER ALLOY
- 3. LEADFRAME PLATING: Sn/Pb SOLDER
- 4. DIMENSIONS ARE IN INCHES [MILLIMETERS].
- DIMENSION DOES NOT INCLUDE MOLDFLASH OF 0.15mm PER SIDE.
- 6 DIMENSION DOES NOT INCLUDE MOLDFLASH OF 0.25mm PER SIDE.
- 7. ALL GROUND LEADS MUST BE SOLDERED TO PCB RF GROUND.



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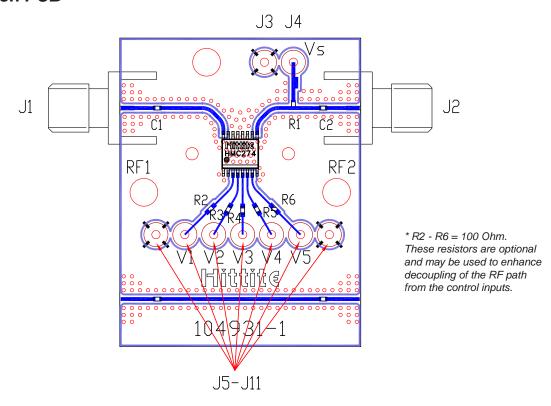
Pin Descriptions

| Pin Number | Function | Description | Interface Schematic |
|------------------|----------|--|---------------------|
| 1, 2, 8, 10 - 15 | GND | This pin must be DC grounded. | |
| 3 - 7 | V1 - V5 | See truth table and control voltage table. | |
| 9 | RF1 | This pin is DC coupled and matched to 50 Ohm. Blocking capacitors are required. | |
| 16 | RF1 | This pin is DC coupled and matched to 50 Ohm. Blocking capacitors are required. | |



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Evaluation PCB



The circuit board used in the final application should use RF circuit design techniques. Signal lines should have 50 ohm impedance while the package ground leads should be connected directly to the ground plane similar to that shown below. A sufficient number of VIA holes should be used to connect the top and bottom ground planes. The evaluation circuit board as shown is available from Hittite Microwave Corporation upon request.

List of Material

| Item | Description | |
|--------------------------------------|--|--|
| J1 - J2 | PC Mount SMA Connector | |
| J3 - J11 | DC Pin | |
| R1 | 5k Ohm Resistor, 0402 Chip | |
| R2 - R6 | 100 Ohm Resistor, 0402 Chip | |
| C1, C2 | 0402 Chip Capacitor, Select for Lowest Frequency of Operation | |
| U1 | HMC274QS16 Digital Attenuator | |
| PCB* | 104931 Evaluation PCB | |
| *Circuit Board Material: Rogers 4350 | | |

This datasheet has been download from:

www.datasheetcatalog.com

Datasheets for electronics components.